

2SB0950 (2SB950), 2SB0950A (2SB950A)

Silicon PNP epitaxial planar type darlington

For power amplification and switching

Complementary to 2SD1276 and 2SD1276A

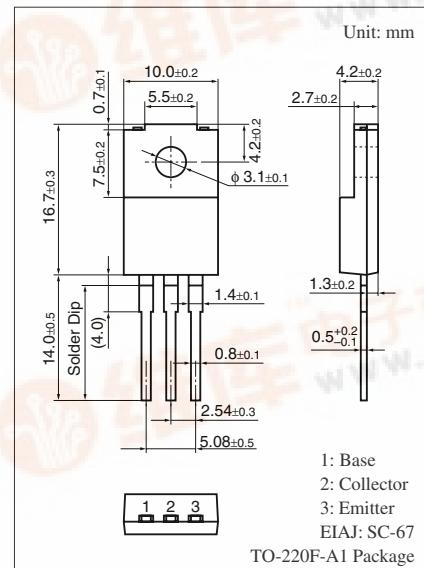
■ Features

- High forward current transfer ratio h_{FE}
- High-speed switching
- Full-pack package which can be installed to the heat sink with one screw

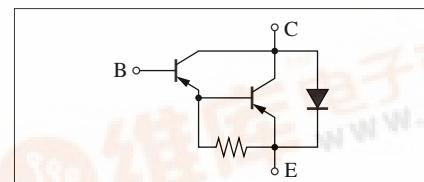
■ Absolute Maximum Ratings $T_C = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	2SB0950	V _{CBO}	-60
	2SB0950A		-80
Collector-emitter voltage (Base open)	2SB0950	V _{CEO}	-60
	2SB0950A		-80
Emitter-base voltage (Collector open)	V _{EBO}	-5	V
Collector current	I _C	-4	A
Peak collector current	I _{CP}	-8	A
Collector power dissipation	T _a = 25°C	P _C	40
			2
Junction temperature	T _j	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

■ Electrical Characteristics $T_C = 25^\circ\text{C} \pm 3^\circ\text{C}$



Internal Connection



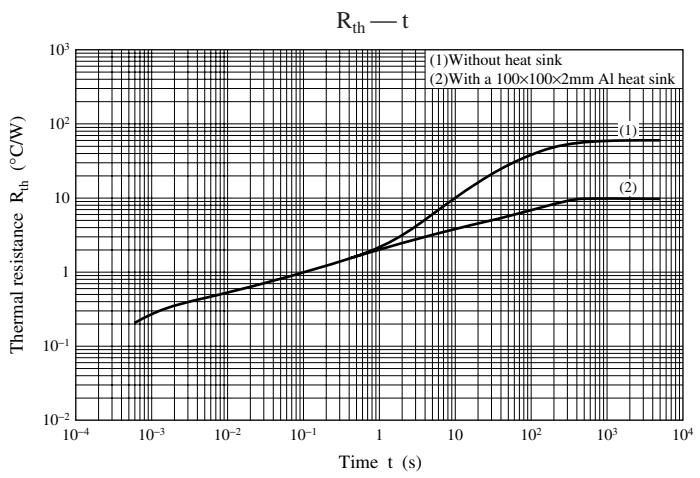
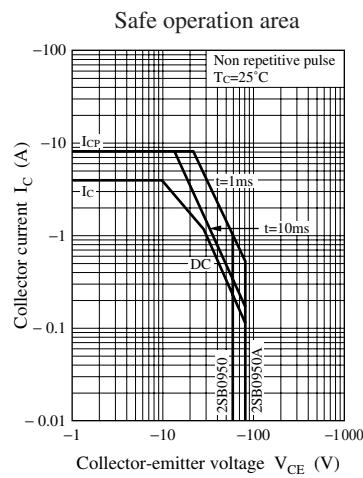
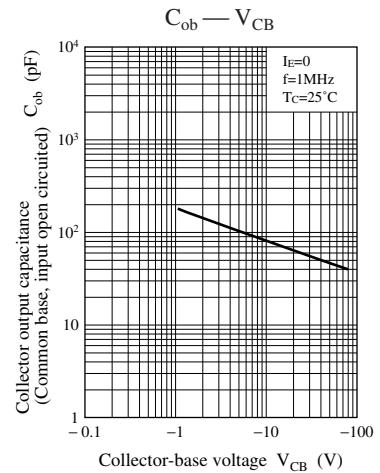
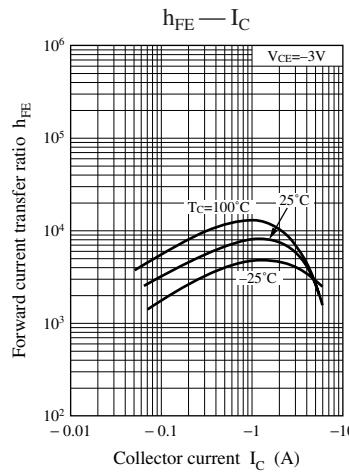
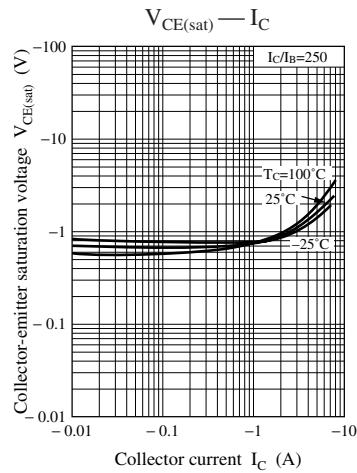
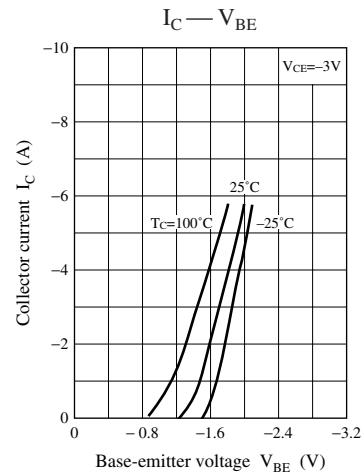
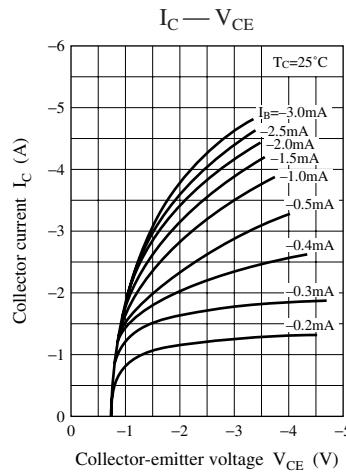
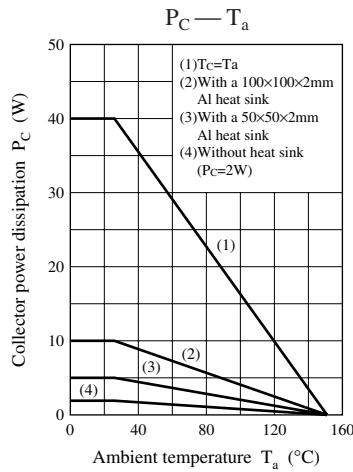
Parameter		Symbol	Conditions	Min	Typ	Max	Unit
Collector-emitter voltage (Base open)	2SB0950	V _{CEO}	I _C = -30 mA, I _B = 0	-60			V
	2SB0950A			-80			
Base-emitter voltage		V _{BE}	V _{CE} = -3 V, I _C = -3 A			-2.5	V
Collector-base cutoff current (Emitter open)	2SB0950	I _{CBO}	V _{CB} = -60 V, I _E = 0			-200	μA
	2SB0950A		V _{CB} = -80 V, I _E = 0			-200	
Collector-emitter cutoff current (Base open)	2SB0950	I _{CEO}	V _{CE} = -30 V, I _B = 0			-500	μA
	2SB0950A		V _{CE} = -40 V, I _B = 0			-500	
Emitter-base cutoff current (Collector open)		I _{EBO}	V _{EB} = -5 V, I _C = 0			-2	mA
Forward current transfer ratio		h _{FE1}	V _{CE} = -3 V, I _C = -0.5 A	1 000			—
		h _{FE2} *	V _{CE} = -3 V, I _C = -3 A	1 000		10 000	
Collector-emitter saturation voltage		V _{CE(sat)1}	I _C = -3 A, I _B = -12 mA			-2	V
		V _{CE(sat)2}	I _C = -5 A, I _B = -20 mA			-4	V
Transition frequency		f _T	V _{CE} = -10 V, I _C = -0.5 A, f = 1 MHz		20		MHz
Turn-on time		t _{on}	I _C = -3 A, I _{B1} = -12 mA, I _{B2} = 12 mA V _{CC} = -50 V		0.3		μs
Storage time		t _{stg}			2		μs
Fall time		t _f			0.5		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

Note) 1. Measuring methods and 2. City Rank classification

Rank	R	Q	P
hse2	1,000 to 2,500	2,000 to 5,000	4,000 to 10,000

Note) The part numbers in the parenthesis show conventional part number



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